

# 3A, 200V - 800V Silicon Rectifiers

#### **FEATURES**

- High efficiency, Low VF
- High current capability
- High reliability
- High surge current capability
- Low power loss
- Compliant to RoHS Directive 2011/65/EU and in accordance to WEEE 2002/96/EC
- Halogen-free according to IEC 61249-2-21

#### **MECHANICAL DATA**

#### Case: DO-201AD

Molding compound, UL flammability classification rating 94V-0 Packing code with suffix "G" means green compound (halogen-free) Terminal: Pure tin plated leads, solderable per JESD22-B102 Meet JESD 201 class 1A whisker test Weight: 1.2 g (approximately)









MAXIMUM RATINGS AND ELECTRICAL CHARACTERSTICS (TA=25°C unless otherwise noted)							
PARAMETER	SYMBOL	BY251	BY252	BY253	BY254	UNIT	
Maximum repetitive peak reverse voltage	V <sub>RRM</sub>	200	400	600	800	V	
Maximum RMS voltage	V <sub>RMS</sub>	140	280	420	560	V	
Maximum DC blocking voltage	V <sub>DC</sub>	200	400	600	800	V	
Maximum average forward rectified current	IF(AV)	3				Α	
Peak forward surge current, 8.3 ms single half sine-wave superimposed on rated load	I <sub>FSM</sub>	150			A		
Maximum instantaneous forward voltage (Note 1) @ 3 A	V <sub>F</sub>	1.0			V		
Maximum reverse current @ rated $V_R$ T <sub>J</sub> =25°C	I <sub>R</sub>	5 100			μA		
Typical junction capacitance (Note 2)	CJ	40				pF	
Typical thermal resistance	R <sub>θJA</sub>	40		°C/W			
Operating junction temperature range	TJ	- 55 to +150			°C		
Storage temperature range	T <sub>STG</sub>	- 55 to +150			°C		
Note1: Pulse Test with PW=300µs, 1% Duty Cycle	•						

Note1: Pulse Test with PW=300µs, 1% Duty Cycle

Note2: Measured at 1 MHz and Applied Reverse Voltage of 4.0V D.C.



Taiwan Semiconductor

## ORDERING INFORMATION

PART NO.	PACKING CODE	PACKING CODE	CKING CODE PACKAGE PACKI					
		SUFFIX <sup>(*)</sup>						
D)/05	A0		DO-201AD	500 / Ammo box				
BY25x (Note 1)	R0	G	DO-201AD	1,250 / 13" Paper reel				
	B0		DO-201AD	500 / Bulk packing				

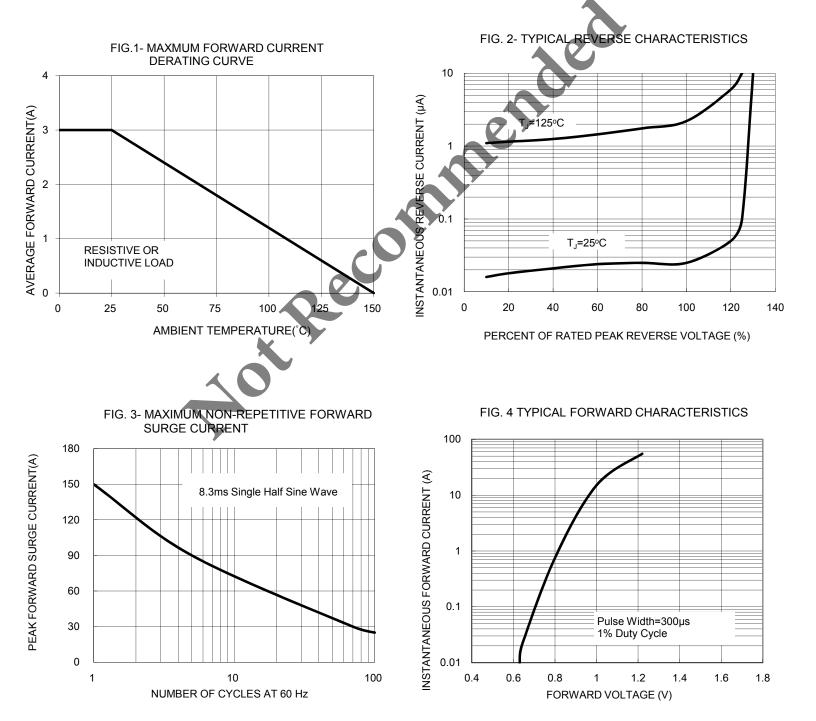
Note 1: "x" defines voltage from 200V (BY251) to 800V (BY254)

\*: Optional available

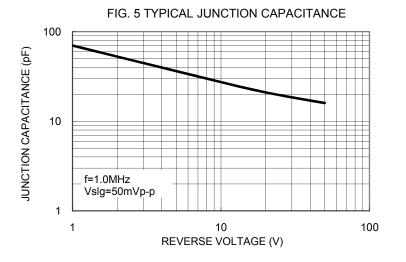
EXAMPLE								
PREFERRED P/N	PART NO.	PACKING CODE	PACKING CODE SUFFIX	DESCRIPTION				
BY251 A0G	BY251	A0	G	Green compound				

### **RATINGS AND CHARACTERISTICS CURVES**

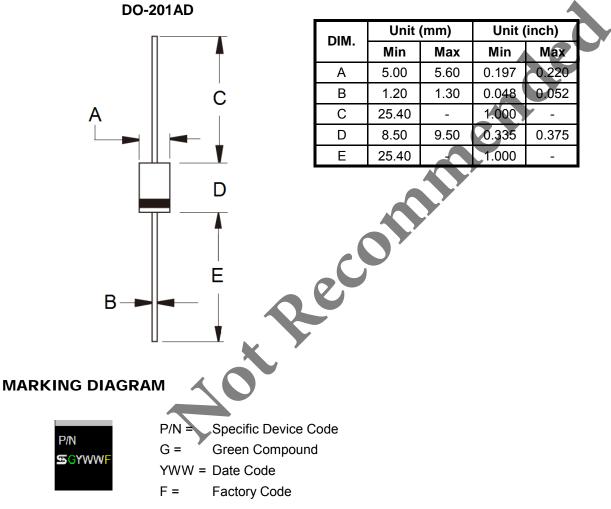
 $(T_A=25^{\circ}C \text{ unless otherwise noted})$ 















Specifications of the products displayed herein are subject to change without notice. TSC or anyone on its behalf, assumes no responsibility or liability for any errors or inaccuracies.

Information contained herein is intended to provide a product description only. No license, express or implied, to any intellectual property rights is granted by this document. Except as provided in TSC's terms and conditions of sale for such products, TSC assumes no liability whatsoever, and disclaims any express or implied warranty, relating to sale and/or use of TSC products including liability or warranties relating to fitness for a particular purpose, merchantability, or infringement of any patent, copyright, or other intellectual property right.

The products shown herein are not designed for use in medical, life-saving, or life-sustaining applications. Customers using or selling these products for use in such applications do so at their own risk and agree to fully indemnify TSC for any damages resulting from such improper use or sale.

Document Number: DS\_D1406026

# **Mouser Electronics**

Authorized Distributor

Click to View Pricing, Inventory, Delivery & Lifecycle Information:

Taiwan Semiconductor:

<u>BY251</u> <u>BY252</u> <u>BY253</u> <u>BY254</u> <u>BY252</u> <u>ROG</u> <u>BY251</u> <u>ROG</u> <u>BY253</u> <u>ROG</u> <u>BY254</u> <u>ROG</u> <u>BY252</u> <u>RO</u> <u>BY252</u> <u>RO</u> <u>BY253</u> <u>RO</u>